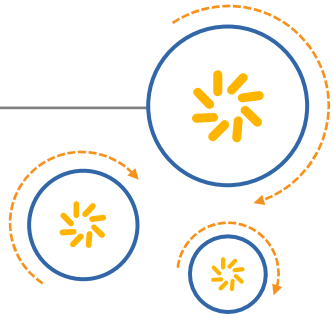
RF360 Europe GmbH

A Qualcomm – TDK Joint Venture



SAW components

SAW Tx post PA filter

TD-LTE band 41 (2535-2655 MHz)

Series/type:	B8870
Ordering code:	B39262B8870L210
Date:	June 06, 2017
Version:	2.0

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RF360 Europe GmbH, Anzinger Str. 13, München, Germany

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1 Application

- TD-LTE band 41 (2535 – 2655 MHz)Post PA Tx filter
- Low-loss RF filter for mobile telephone
- Usable pass band 120 MHz
- 50Ω / 50Ω unbalanced to unbalanced operation for all filters

2 Features

- Package size 1.1±0.05 mm × 0.9±0.05 mm
- Package height 0.6 mm (max.)
- Approximate weight 1 mg
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 3 (MSL3)

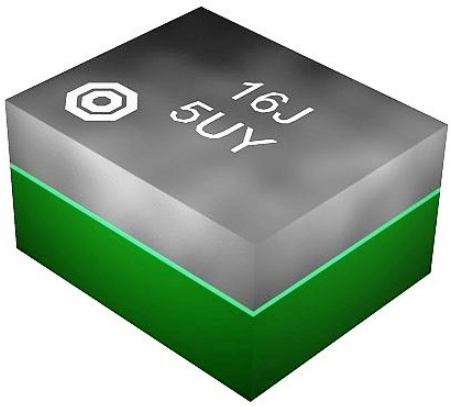

Figure 1: Picture of component with example of product marking.

3 Package

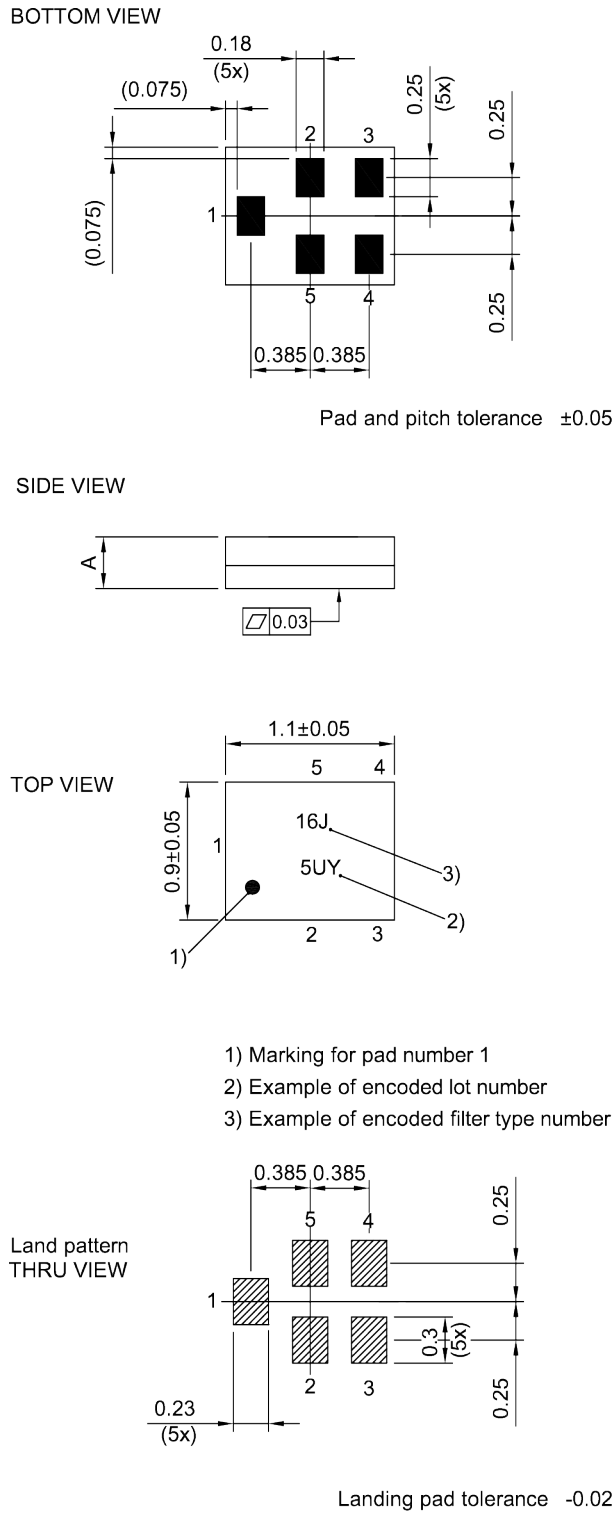

Figure 2: Drawing of package with package height A = 0.6 mm (max.). See Sec. Package information (p. 19).

4 Pin configuration

- 1 Input
- 4 Output
- 2, 3, 5 Ground

5 Matching circuit

- L_{p1} = 3.3 nH
- L_{p4} = 4.0 nH

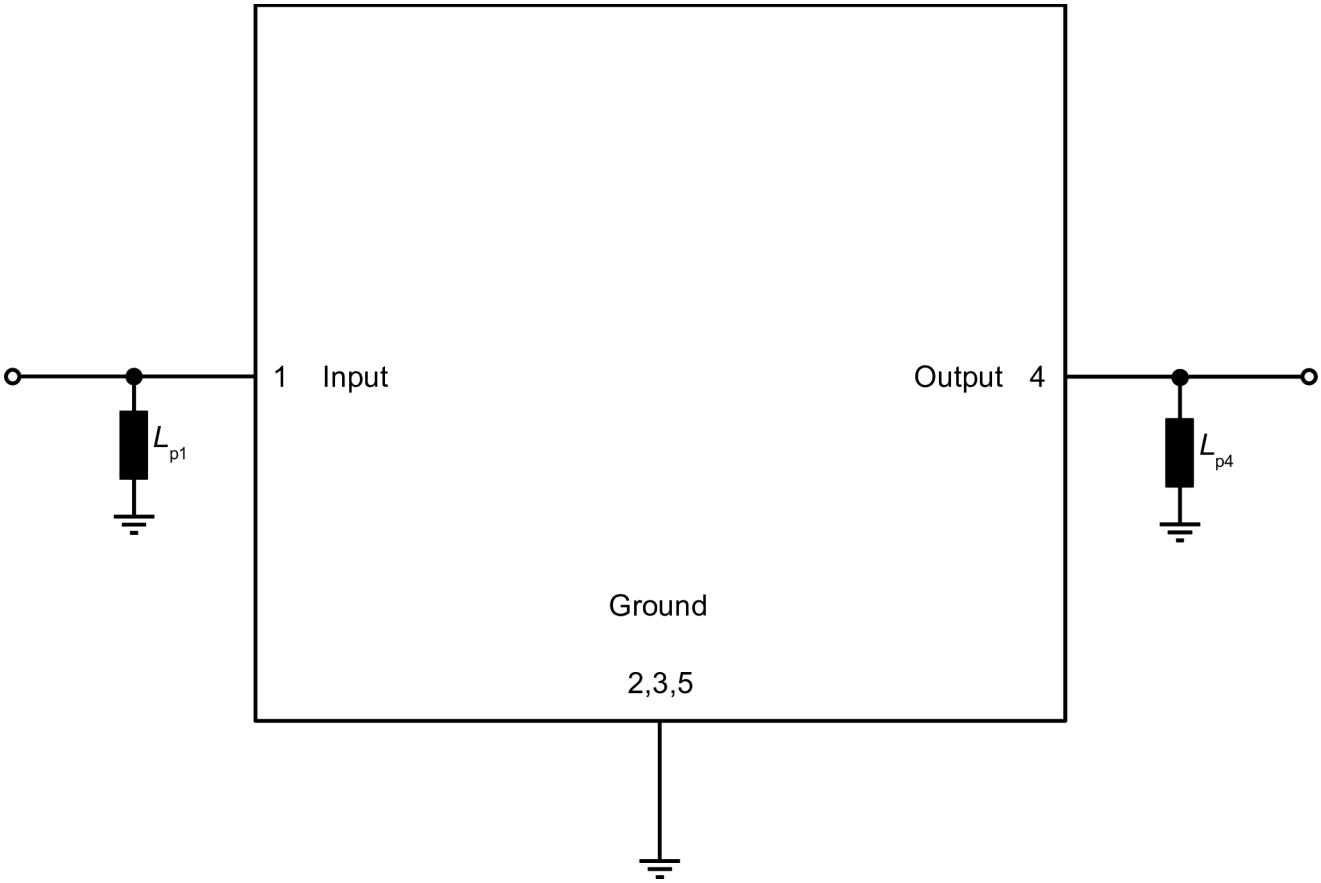

Figure 3: Schematic of matching circuit.

External shunt inductor for ESD protection is recommended at any ports towards antenna.

6 Characteristics

Temperature range for specification T_{SPEC} = −30 °C ... +85 °C
Input terminating impedance Z_{IN} = 50 Ω with par. 3.3 nH[1)]
Output terminating impedance Z_{OUT} = 50 Ω with par. 4.0 nH[1)]

Characteristics				min. for T_{SPEC}	typ. @ +25 °C	max. for T_{SPEC}	
Center frequency			f_C	—	2595	—	MHz
Maximum insertion attenuation			α_{max}				
	2535... 2555	MHz		—	1.6	2.8	dB
	2545... 2575	MHz		—	1.3	2.5	dB
	2555... 2575	MHz		—	1.1	2.2	dB
	2555... 2655	MHz		—	1.7	2.8	dB
	2575... 2635	MHz		—	1.2	2.2	dB
	2635... 2655	MHz		—	1.7	2.8	dB
Amplitude ripple (p-p)			$\Delta\alpha$				
	2535... 2655	MHz		—	0.7	2.0	dB
Maximum VSWR			$VSWR_{max}$				
@ input port	2535... 2655	MHz		—	1.5	2.0	
@ output port	2535... 2655	MHz		—	1.5	2.0	
Average attenuation			$\alpha_{WLAN,avg}$ [2)]				
WiFi ch1 – ch3	2403... 2431	MHz		45	49	—	dB
WiFi ch4 – ch8	2418... 2456	MHz		40	46	—	dB
WiFi ch9 – ch13	2443... 2481	MHz		45	49	—	dB
Minimum attenuation			α_{min}				
	50... 699	MHz		40	48	—	dB
	699... 916	MHz		35	40	—	dB
	916... 925	MHz		35	40	—	dB
	925... 960	MHz		35	39	—	dB
	960... 1440	MHz		23	27	—	dB
	1440... 1565	MHz		20	25	—	dB
	1565... 1615	MHz		20	24	—	dB
	1615... 1805	MHz		20	23	—	dB
	1805... 1830	MHz		20	23	—	dB
	1830... 2120	MHz		20	23	—	dB
	2120... 2400	MHz		20	25	—	dB
	2400... 2483	MHz		40	46	—	dB
	2775... 4990	MHz		25	30	—	dB
	4990... 5900	MHz		30	39	—	dB
	6000... 6900	MHz		30	39	—	dB
	7000... 7990	MHz		20	29	—	dB

[1)] See Sec. Matching circuit (p. 6).

2) Average over each WLAN channel with band width of 18 MHz.

7 Maximum ratings

Storage temperature	T_{STG} [1] = −40 °C ... +85 °C	
DC voltage	$\lvert V_{DC} \rvert$ = 5.0 V (max.)	
ESD voltage		
	V_{ESD} [2] = 50 V (max.)	Machine model.
	V_{ESD} [3] = 150 V (max.)	Human body model.
	V_{ESD} [4] = 600 V (max.)	Charged device model.
Input power	P_{IN}	
@ input port: 2535 ... 2655 MHz	29 dBm	5 MHz TD-LTE uplink signal for 5000 h @ 50 °C.
@ input port: other frequency ranges	10 dBm	5 MHz TD-LTE uplink signal for 5000 h @ 50 °C.

1) Not valid for packaging material. Storage temperature for packaging material is −25 °C to +40 °C.
2) According to JESD22-A115B (MM – Machine Model), 10 negative & 10 positive pulses.
3) According to JESD22-A114F (HBM – Human Body Model), 1 negative & 1 positive pulse.
4) According to JESD22-C101C (CDM – Field Induced Charged Device Model), 3 negative & 3 positive pulses.

8 Transmission coefficient

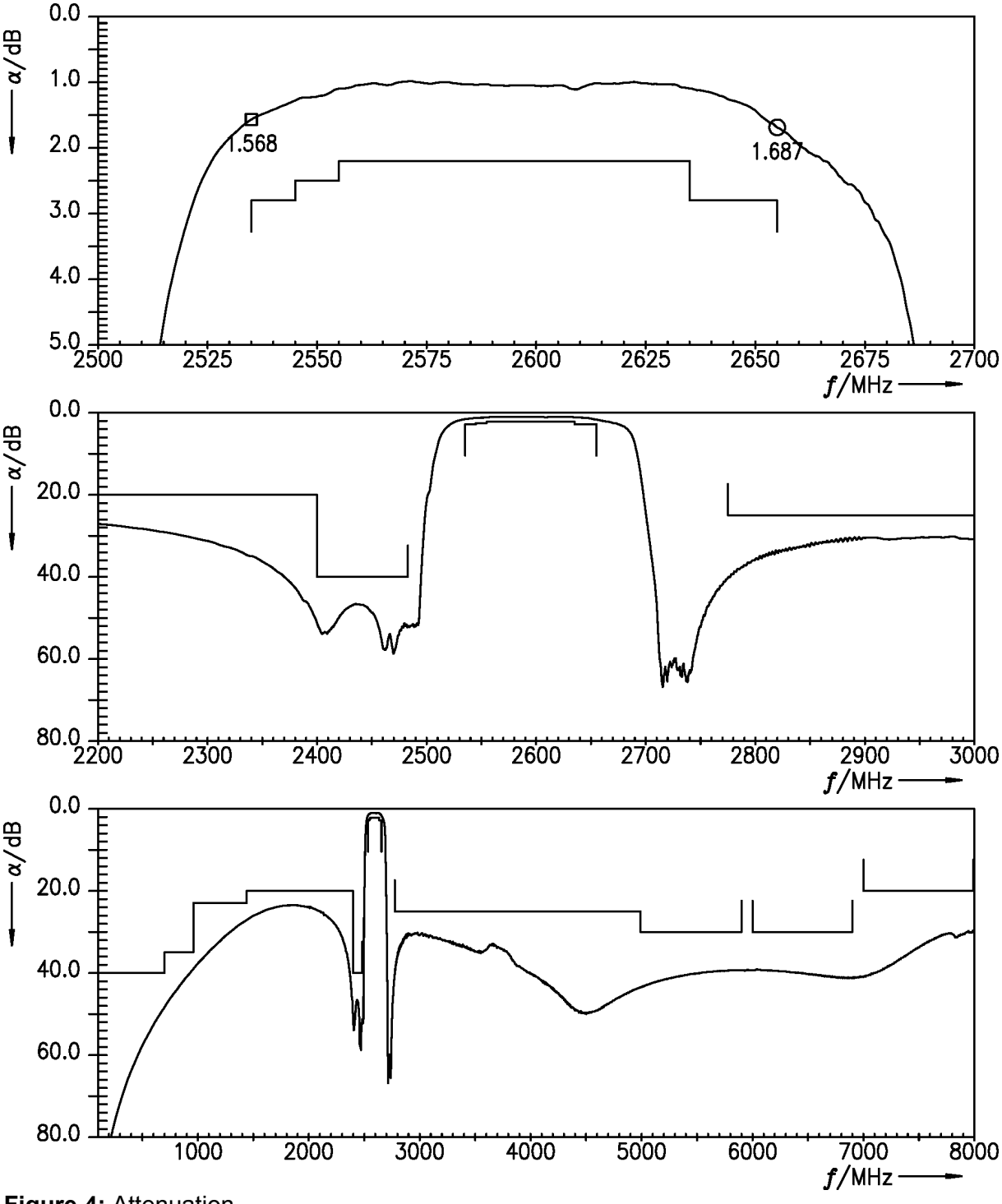

Figure 4: Attenuation.

9 Reflection coefficients

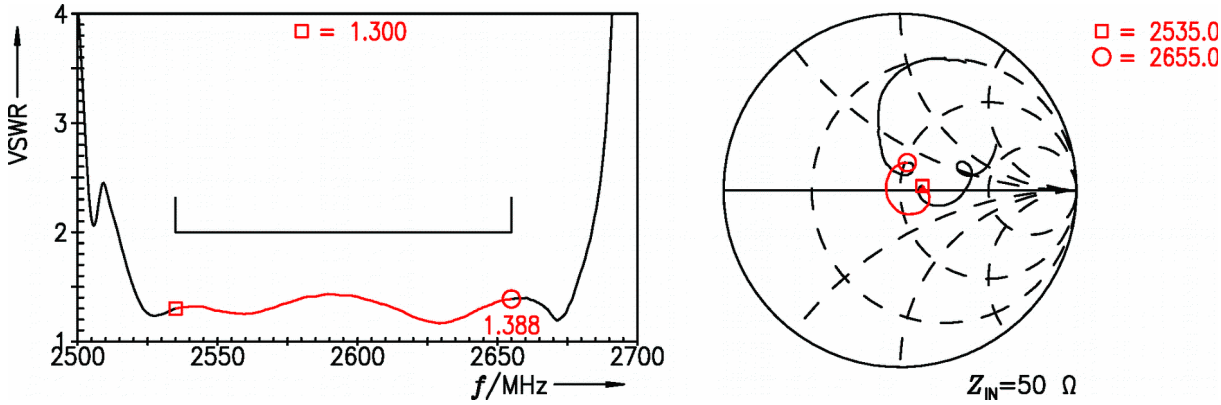

Figure 5: Reflection coefficient at IN port.

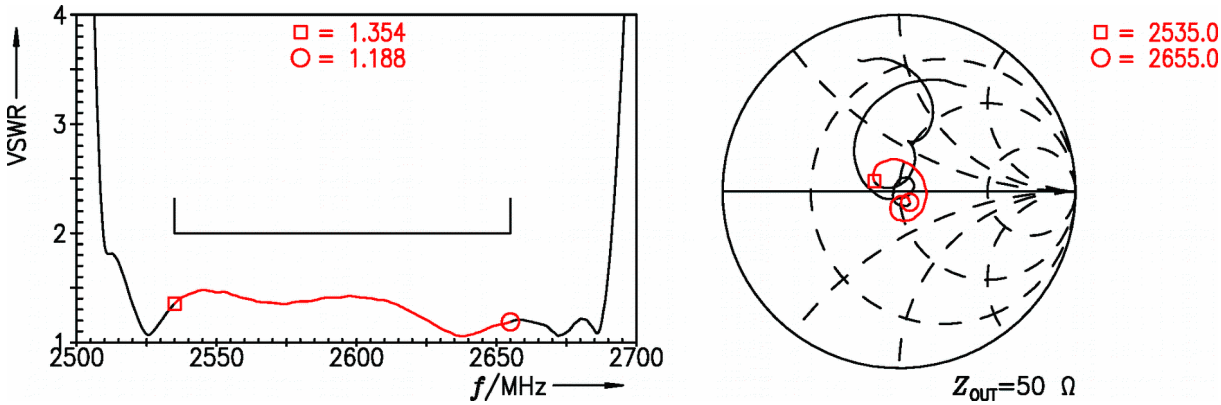

Figure 6: Reflection coefficient at OUT port.

10 Packing material

10.1 Tape

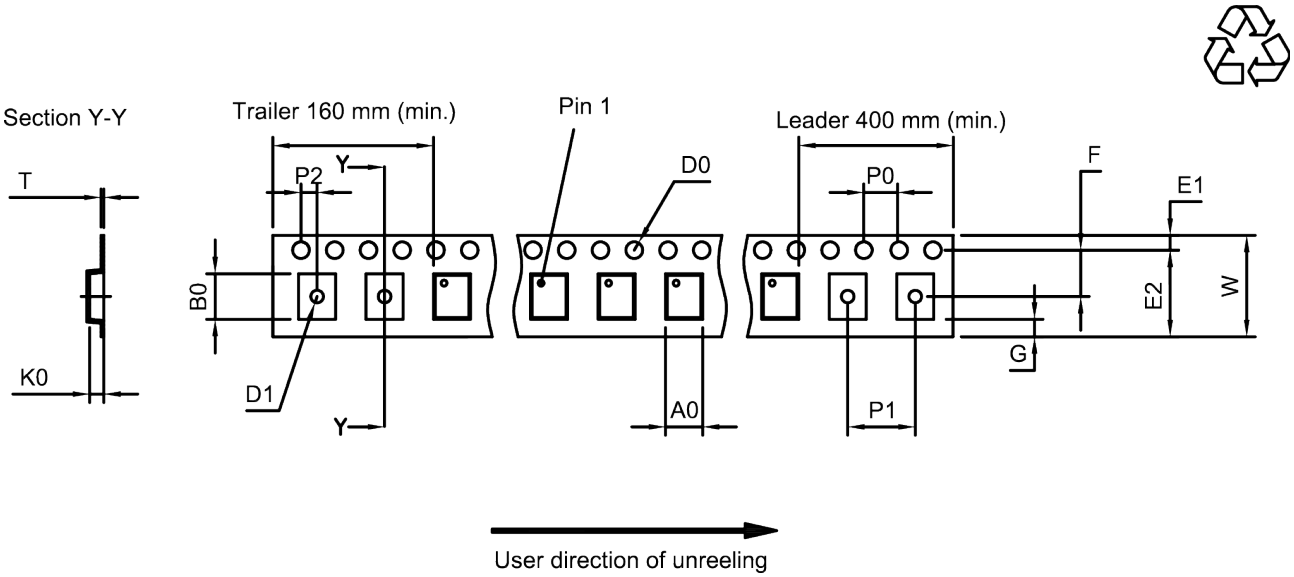

Figure 7: Drawing of tape (first-angle projection) with tape dimensions according to Table 1.

A_0	1.05±0.05 mm
B_0	1.25±0.05 mm
D_0	1.5+0.1/ -0.00 mm
D_1	0.4±0.05 mm
E_1	1.75±0.1 mm

E_2	6.25 mm (min.)
F	3.5±0.05 mm
G	0.75 mm (min.)
K_0	0.63±0.05 mm
P_0	4.0±0.1 mm

P_1	2.0±0.05 mm
P_2	2.0±0.05 mm
T	0.2±0.02 mm
W	8.2±0.1 mm

Table 1: Tape dimensions.

10.2 Reel with diameter of 180 mm

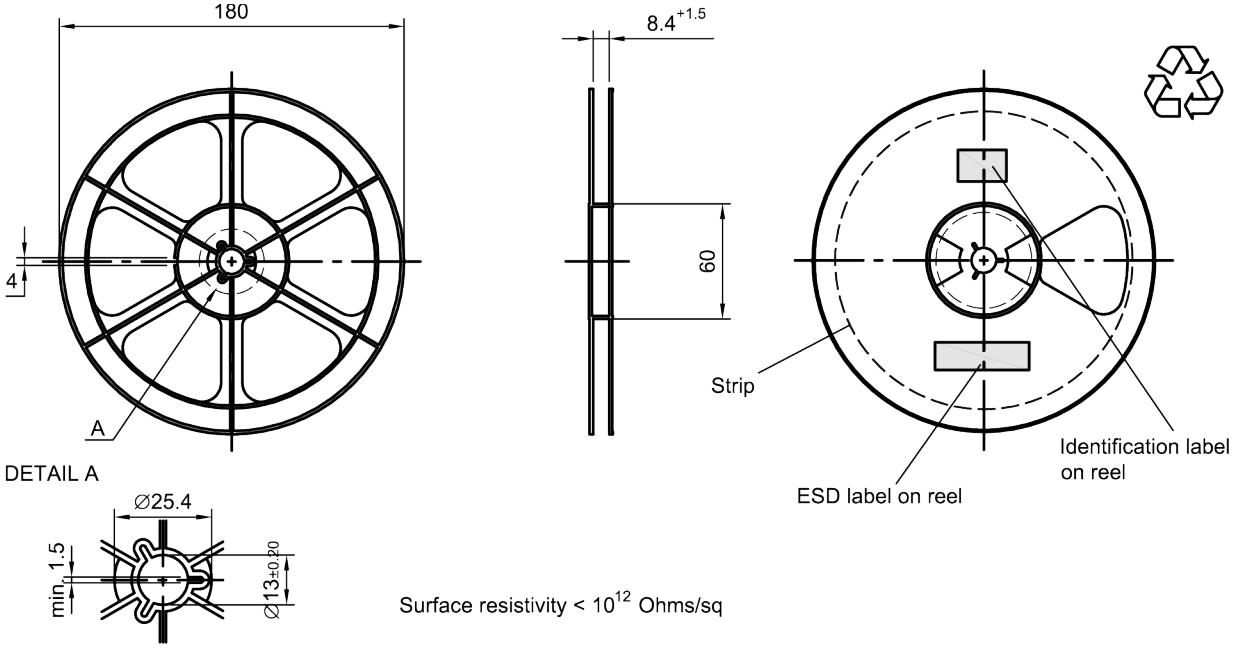

Figure 8: Drawing of reel (first-angle projection) with diameter of 180 mm.

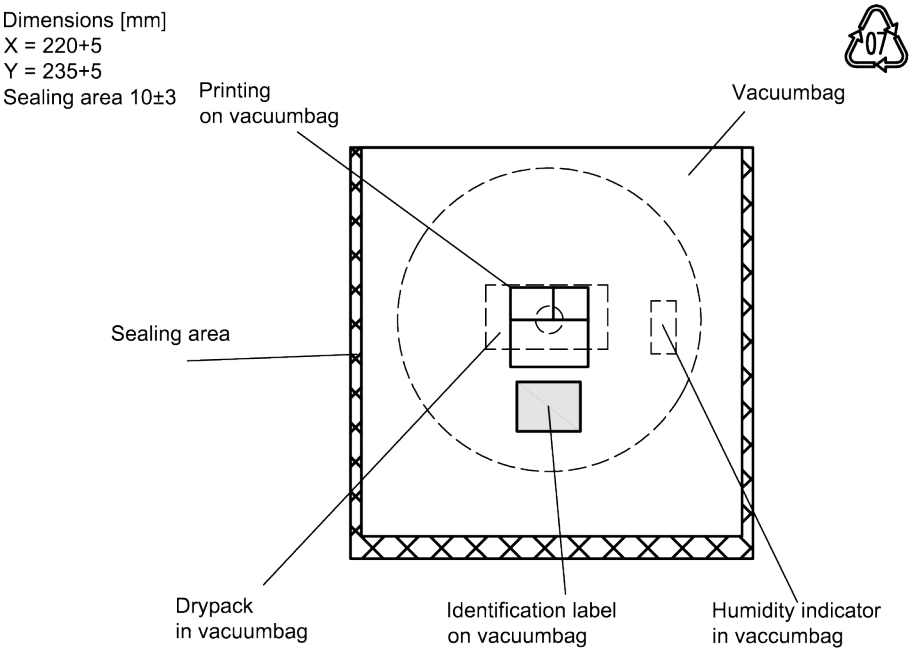

Figure 9: Drawing of moisture barrier bag (MBB) for reel with diameter of 180 mm.

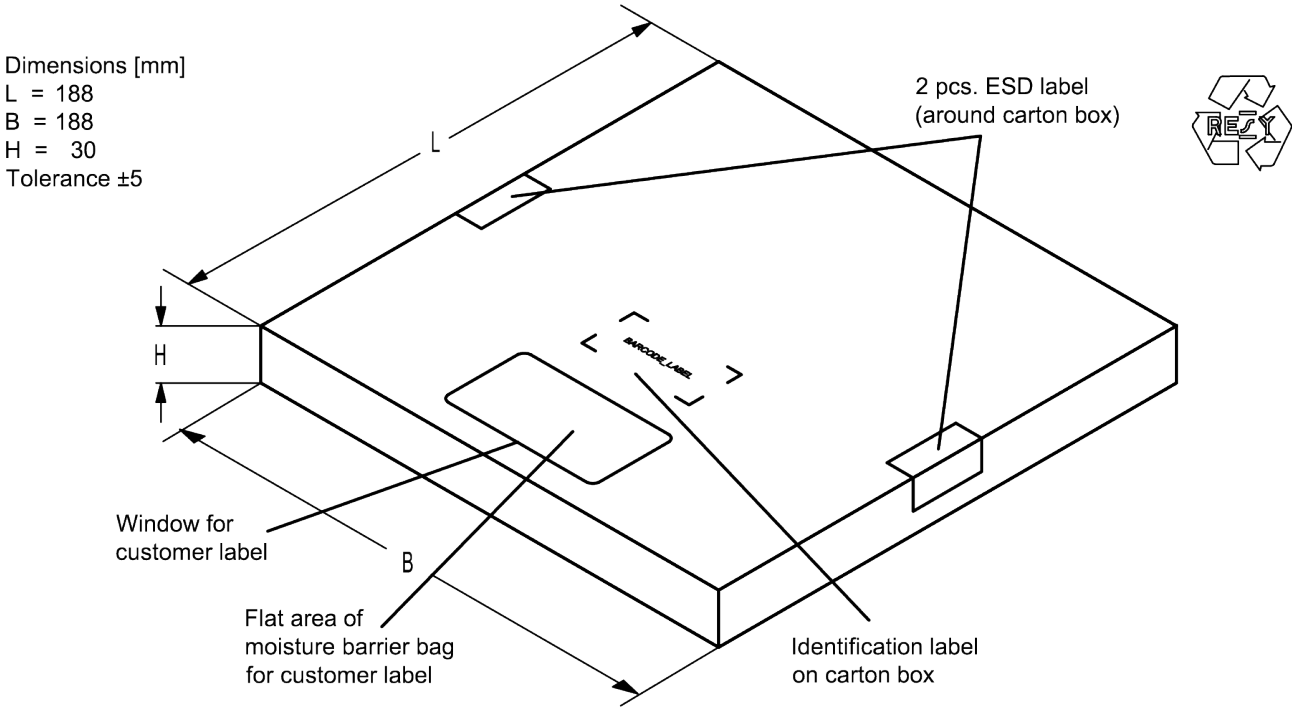

Figure 10: Drawing of folding box for reel with diameter of 180 mm.

10.3 Reel with diameter of 330 mm

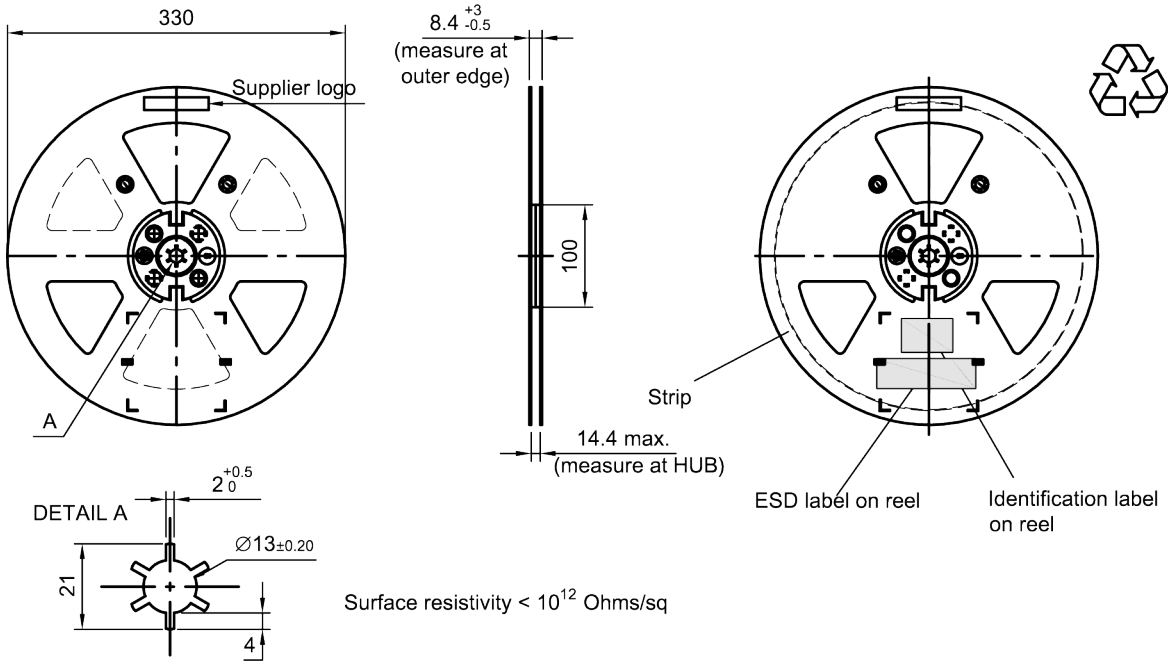

Figure 11: Drawing of reel (first-angle projection) with diameter of 330 mm.

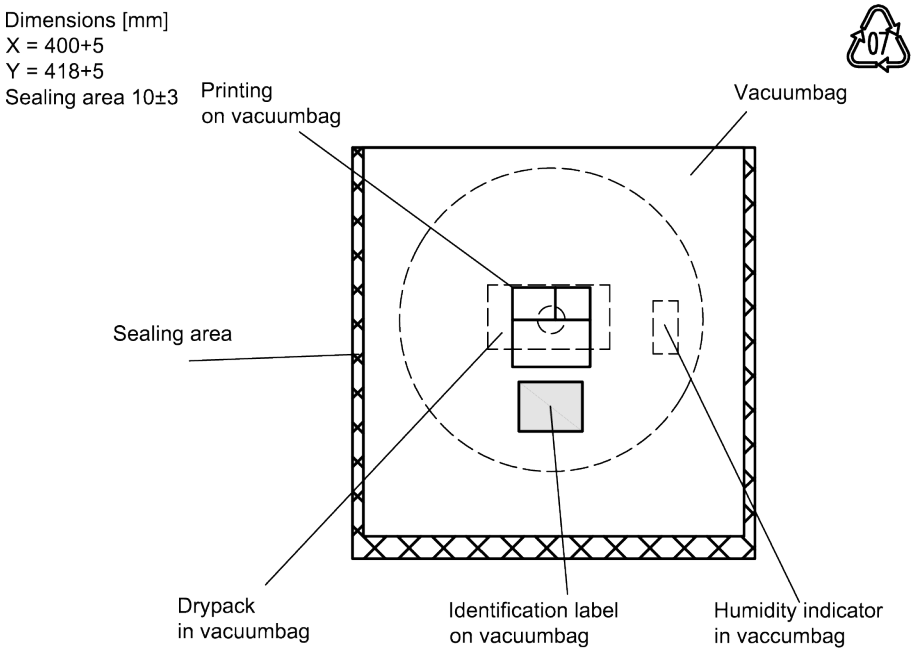

Figure 12: Drawing of moisture barrier bag (MBB) for reel with diameter of 330 mm.

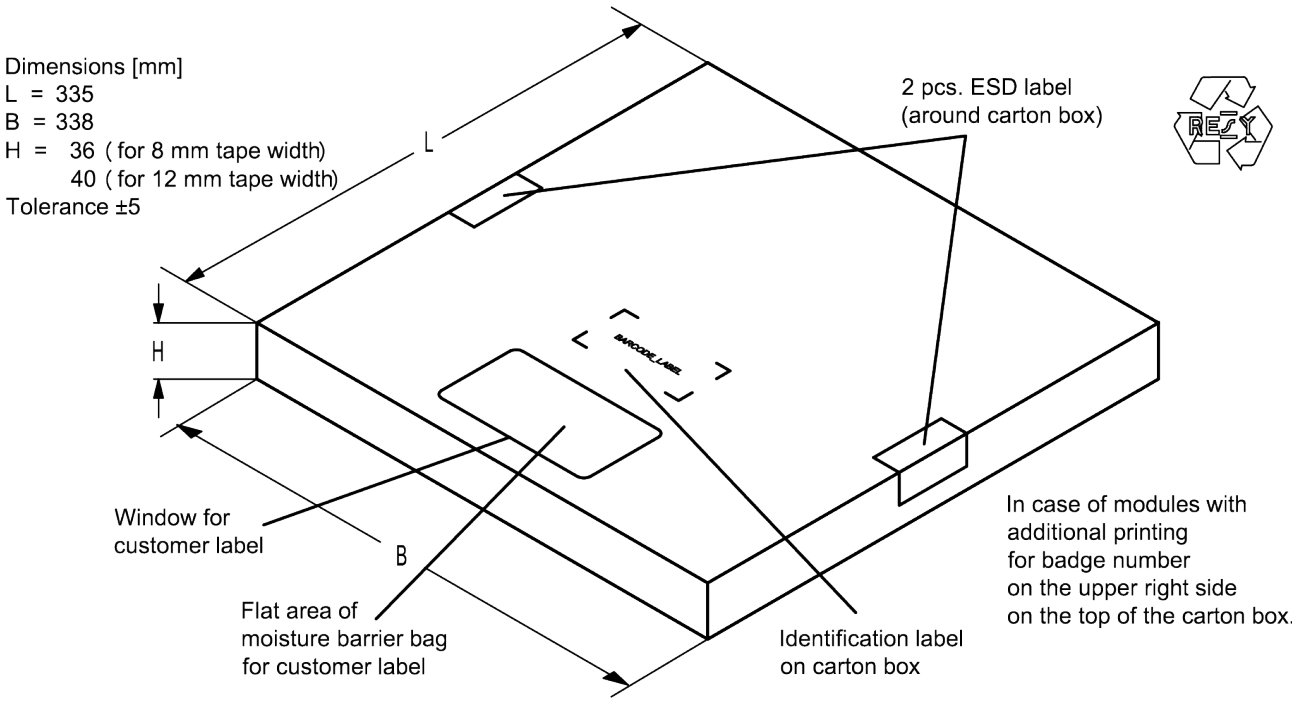

Figure 13: Drawing of folding box for reel with diameter of 330 mm.

11 Marking

Products are marked with product type number and lot number encoded according to Table 2:

- Type number:

  The 4 digit type number of the ordering code, e.g., B3xxxxB**1234**xxxx,
  is encoded by a special BASE32 code into a 3 digit marking.

  Example of decoding type number marking on device in decimal code.
  16J **=>** **1234**
  1 x 32^2 + **6** x 32^1 + **18 (=J)** x 32^0 **=** **1234**
  The BASE32 code for product type B8870 is 8N6.

- Lot number:

  The last 5 digits of the lot number, e.g., **12345**,
  are encoded based on a special BASE47 code into a 3 digit marking.

  Example of decoding lot number marking on device in decimal code.
  5UY **=>** **12345**
  5 x 47^2 + **27 (=U)** x 47^1 + **31 (=Y)** x 47^0 **=** **12345**

Adopted BASE32 code for type number			
Decimal value	Base32 code	Decimal value	Base32 code
0	0	16	G
1	1	17	H
2	2	18	J
3	3	19	K
4	4	20	M
5	5	21	N
6	6	22	P
7	7	23	Q
8	8	24	R
9	9	25	S
10	A	26	T
11	B	27	V
12	C	28	W
13	D	29	X
14	E	30	Y
15	F	31	Z

Adopted BASE47 code for lot number			
Decimal value	Base47 code	Decimal value	Base47 code
0	0	24	R
1	1	25	S
2	2	26	T
3	3	27	U
4	4	28	V
5	5	29	W
6	6	30	X
7	7	31	Y
8	8	32	Z
9	9	33	b
10	A	34	d
11	B	35	f
12	C	36	h
13	D	37	n
14	E	38	r
15	F	39	t
16	G	40	v
17	H	41	\
18	J	42	?
19	K	43	{
20	L	44	}
21	M	45	<
22	N	46	>
23	P		

Table 2: Lists for encoding and decoding of marking.

12 Soldering profile

The recommended soldering process is in accordance with IEC 60068-2-58 – 3rd edit and IPC/JEDEC J-STD-020B.

ramp rate	≤ 3 K/s
preheat	125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s
T > 220 °C	30 s to 70 s
T > 230 °C	min. 10 s
T > 245 °C	max. 20 s
T ≥ 255 °C	–
peak temperature T_{peak}	250 °C +0/-5 °C
wetting temperature T_{min}	230 °C +5/-0 °C for 10 s ± 1 s
cooling rate	≤ 3 K/s
soldering temperature T	measured at solder pads

Table 3: Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).

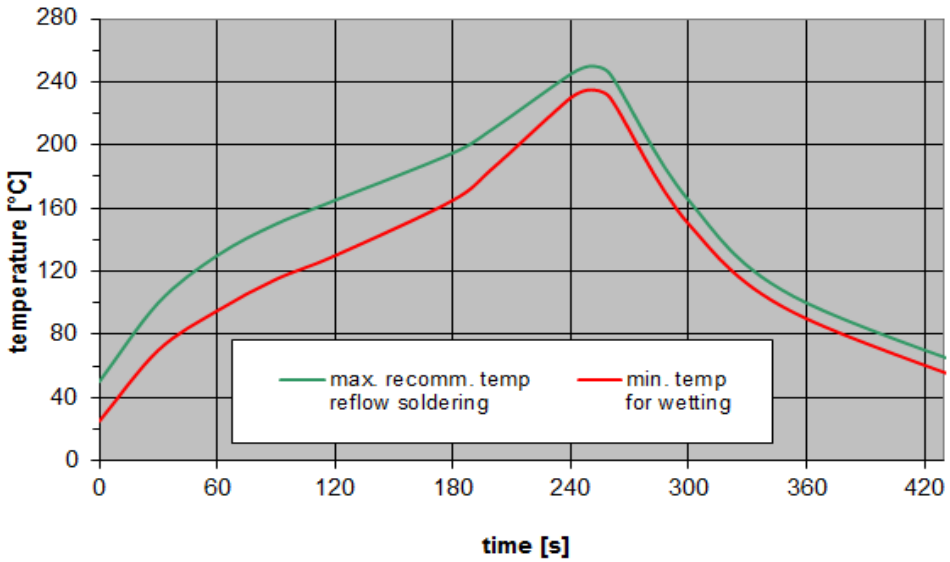

Figure 14: Recommended reflow profile for convection and infrared soldering – lead-free solder.

13 Annotations

13.1 Matching coils

See TDK inductor pdf-catalog http://www.tdk.co.jp/tefe02/coil.htm#aname1 and Data Library for circuit simulation http://www.tdk.co.jp/etvcl/index.htm.

13.2 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

13.3 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local RF360 sales office.

13.4 Ordering codes and packing units

Ordering code	Packing unit
B39262B8870L210	15000 pcs
B39262B8870L210S 5	5000 pcs

Table 4: Ordering codes and packing units.

14 Cautions and warnings

14.1 Display of ordering codes for RF360 products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of RF360, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under www.rf360jv.com/orderingcodes.

14.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

For information on recycling of tapes and reels please contact one of our sales offices.

14.3 Moldability

Before using in overmolding environment, please contact your local RF360 sales office.

14.4 Package information

Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on RF360 internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of RF360, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

Dimensions

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

Projection method

Unless otherwise specified first-angle projection is applied.

Important notes

The following applies to all products named in this publication:

1. Some parts of this publication contain **statements about the suitability of our products for certain areas of application**. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out **that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application.** As a rule, RF360 Europe GmbH and its affiliates are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an RF360 product with the properties described in the product specification is suitable for use in a particular customer application.
2. We also point out that **in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified.** In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
3. **The warnings, cautions and product-specific notes must be observed.**
4. In order to satisfy certain technical requirements, **some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous)**. Useful information on this will be found in our Material Data Sheets on the Internet (www.rf360jv.com/material). Should you have any more detailed questions, please contact our sales offices.
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